TOSHIBA Photocoupler GaAs Ired & Photo-Triac

TLP360J

Triac Drivers
Programmable Controllers
AC-Output Modules
Solid State Relays

The TOSHIBA TLP360J consists of a photo-triac optically coupled to a gallium arsenide infrared-emitting diode in a four-lead plastic DIP package.

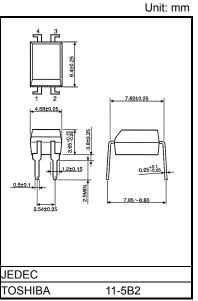
- · Peak off-state voltage: 600 V (Min.)
- Trigger LED current: 10 mA (Max.)
- · On-state current: 100 mA (Max.)
- · Isolation voltage: 5000 Vrms (Max.)
- · UL recognized: UL1577, file No. E67349
- · Option (D4) type

TÜV approved: DIN EN60747-5-2

Certificate No. R50033433

Maximum operating insulation voltage : 890 Vpk
Maximum permissible overvoltage : 8000 Vpk

(Note) When an EN60747-5-2 approved type is needed, please designate "Option (D4)."



Weight: 0.26 g (Typ.)

· Construction mechanical rating

	7.62 mm pitch standard type	10.16 mm pitch TLPXXXF type
Creepage distance	7.0 mm (min)	8.0 mm (min)
Clearance	7.0 mm (min)	8.0 mm (min)
Insulation thickness	0.4 mm (min)	0.4 mm (min)

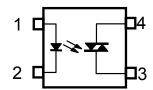
Trigger LED Current

Classi– fication*		current (mA) Ta = 25°C	Marking of classification
lication	Min.	Max.	Classification
(IFT7)	_	7	T7
Standard	_	10	T7, blank

^{*}Example: "(IFT7)"; "TLP360J(IFT7)"

(Note) When specifying the application type name for certification testing, be sure to use the standard product type name, e.g., TLP360J(IFT7): TLP360J.

Pin Configuration (top view)



- 1: Anode
- 2: Cathode
- 3: Terminal1
- 4: Terminal2

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TLP360J



Absolute Maximum Ratings (Ta = 25°C)

Characteristic				Rating	Unit	
	Forward current		I _F	50	mA	
	Forward current derating (Ta ≥ 53°C)		ΔI _F /°C	-0.7	mA /°C	
LED	Peak forward current (100 µs pulse, 100 pps)		I _{FP}	1	Α	
	Reverse voltage		V _R	5	V	
	Junction temperature		Tj	125	°C	
Off-state output terminal voltage				600	V	
	On-state RMS current	Ta = 25°C	IT(DMO)	100	mA	
'n	On-State Kind Current	Ta = 70°C	I _{T(RMS)}	50		
etecto	On-state current derating (Ta ≥ 25°C) Peak on-state current (100 µs pulse, 120 pps)		ΔI _T /°C	-1.1	mA /°C	
ă			I _{TP}	2	Α	
Peak nonrepetitive surge current (Pw = 10 ms, DC = 10%)			I _{TSM}	1.2	Α	
	Junction temperature	Tj	115	°C		
Stor	rage temperature range	T _{stg}	-55~125	°C		
Operating temperature range			T _{opr}	-40~100	°C	
Lea	Lead soldering temperature (10 s)			260	°C	
Isola	Isolation voltage (AC, 1 min., R.H.≤ 60%) (Note 1)			5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pins 1 and 2 are shorted together and pins 3 and 4 are shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{AC}	_	_	240	V _{ac}
Forward current	I _F	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition		Тур.	Max.	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	Ст	V = 0, f = 1 MHz	_	30	_	pF
	Peak off-state current	I _{DRM}	V _{DRM} = 600 V	_	10	1000	nA
L	Peak on-state voltage	V _{TM}	I _{TM} = 100 mA	_	1.7	3.0	V
Detector	Holding current	ΙΗ	_	_	0.6	_	mA
Det	Critical rate of rise of off-state voltage	dv/dt	Vin = 240 Vrms , Ta = 85°C (Note 2)	_	500	-	V/µs
	Critical rate of rise of commutating voltage	dv/dt(c)	Vin = 60 Vrms , I _T = 15 mA (Note 2)		0.2		V/µs

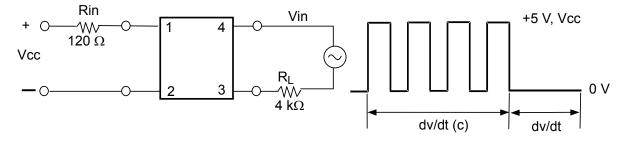
Coupled Electrical Characteristics (Ta = 25°C)

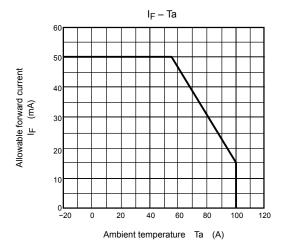
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	l _{FT}	V _T = 6 V		_	10	mA
Turn-on time		V_D = 6 \rightarrow 4 V , R_L = 100 Ω	_	30	100	μs
	ton	I _F = Rated I _{FT} X1.5		30		

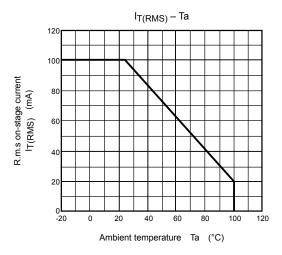
Isolation Characteristics (Ta = 25°C)

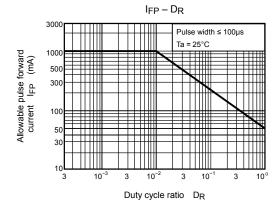
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance (input to output)	CS	V _S = 0 , f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	1×10 ¹²	10 ¹⁴	_	Ω
Isolation voltage	BV_S	AC, 1 minute	5000	_	_	Vrms
		AC, 1 second, in oil	_	10000	_	VIIIIS
		DC, 1 minute, in oil	_	10000		Vdc

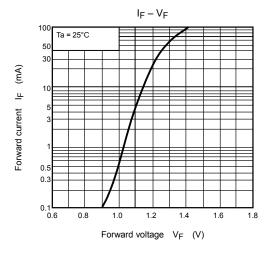
(Note 2): dv/dt test circuit

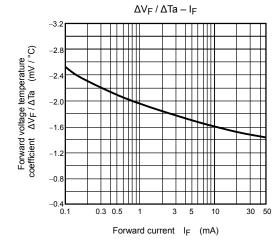


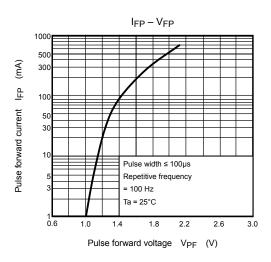






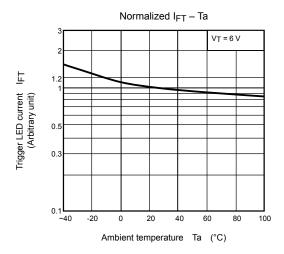


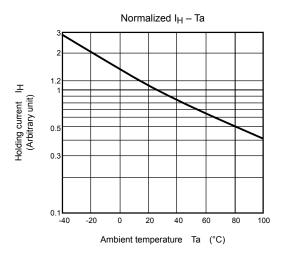


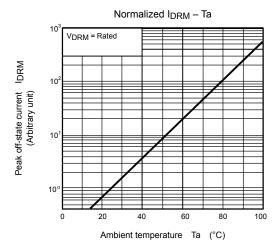


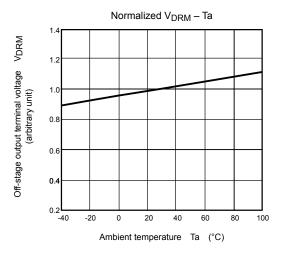
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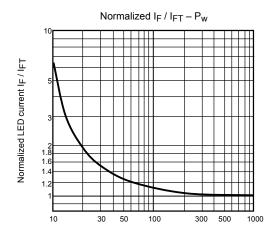
^{*:} The above graphs show typical characteristics.











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RESTRICTIONS ON PRODUCT USE

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
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